KAMAYA OHM

Spec. No.: RHC-K-HTS-0001 /8
Date: 2017. 1. 10

Specification

Title: FIXED THICK FILM CHIP RESISTORS;

RECTANGULAR TYPE & HIGH OHM

Style: RHC16,20

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Product specification contained in this specification are subject to change at any time without notice If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

Note: Stock conditions

Temperature: $+5^{\circ}$ C ~ $+35^{\circ}$ C Relative humidity: 25% ~ 75%

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

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1. Scope

1.1 This specification covers the detail requirements for fixed thick film chip resistors; rectangular type & high ohm, style of RHC16,20.

1.2 Applicable documents

JIS C 5201: 1994, JIS C 5202: 1990

2. Classification

Type designation shall be the following form.

(Example)

RHC	20	10G0	M	TP
1	2	3	4	5
Stv	le			

1 Fixed thick film chip resistors; rectangular type & high ohm

2 Size

3 Rated resistance

10G0	10G0>10GΩ

4 Tolerance on rated resistance

J	±5%	
K	±10%	
М	±20%	
N	±30%	
Н	±50%	

5 Packaging form

В	Bulk (loose package)
TP	Paper taping

3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Table 1					
Style	Rated voltage (V)	Temperature coefficient of resistance (10 ⁻⁶ /°C)	Rated resistance range (Ω)	Tolerance on rated resistance	Preferred number series for resistors
			100M~270M	J(±5%)	
RHC16		0~-2,000	100M~4G	K(±10%)	
	15		100M~150G	M(±20%), N(±30%), H(±50%)	E12
	15	±2,000	100M~1G	J(±5%), K(±10%)	L12
RHC20		±2,000	100M~10G	M(±20%), N(±30%), H(±50%)	
		±4,000	100G~150G	IVI(±20 /0), IV(±30 /0), FI(±30 /0)	

Style	Working temperature range(°C)
RHC16	<i>–</i> 55~+155
RHC20	-55~+125

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3.2 Derating

The derated values of load at temperature in excess of 70 °C shall be as indicated by the following curve.

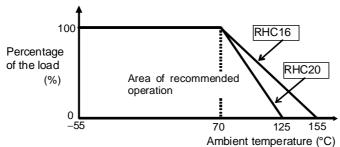


Figure-1 Derating curve

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units
В	Bulk (loose package)		1,000 pcs.
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

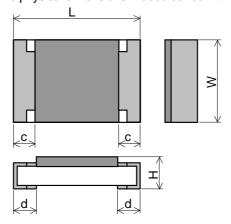


Figure-2

Iable-3					Unit: mm
Style	L	W	Н	С	d
RHC16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.3±0.1	0.3±0.1
RHC20	2.0±0.1	1.25±0.10	0.55±0.10	0.4±0.2	0.4±0.2

5.2 Net weight (Reference)

Style	Net weight(mg)	
RHC16	2	
RHC20	5	

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6. Performance

6.1 The standard condition for tests shall be in accordance with Sub-clause 3, JIS C 5202: 1990.

6.2 The performance shall be satisfied in Table-4.

Table-4(1)

No.	Test items	Condition of test (JIS C 5202)	Performance requirements
1	DC resistance	Sub-clause 5.1	Within the specified tolerance of rated
'	DC resistance		resistance.
2	Tomporatura	Measuring voltage: 15 V	
2	Temperature characteristics of	Sub-clause 5.2	See table–1.
	resistance	Test condition: 5 °C / 35 °C	
3	Voltage coefficient	Sub-clause 5.3	RHC16
3	Voltage coefficient	Measuring voltage: 5 V / 15 V	100MΩ≤R<100GΩ: Within ±1 %/V
		Weasuming Voltage. 5 V / 15 V	100GΩ≤R≤150GΩ: Within ±2 %/V
			RHC20
			100MΩ≤R≤10GΩ: Within 0~-2 %/V
			100GΩ≤R≤150GΩ: Within ±10 %/V
4	Insulation resistance	Sub-clause 5.6	10 TΩ min.
'		The resistor shall be fixed on the test fixture as	10 12211
		shown in Figure 4.	
		Test potential: 100 Vdc	
		Test period: 1 min.	
5	Capacitance	Measuring voltage: 1 V	1 pF max.
		Measuring frequency: 10 kHz, 100kHz, 1MHz	·
	Tanada at atau anti-		Not be explained in the conflict from
6	Terminal strength	Lead wire (RHC16: \phi0.4 mm, RHC20: \phi0.47	Not be peeled off by the pulling force under 5 N.
	(Pulling test)	mm) shall be soldered to the center of terminal.	RHC16: 3 N
		One side is fixed and the specified load shall be applied to the other side in the direction of axial.	KIICIO. 3 N
		Duration: 10 s ± 1 s	
7	Substrate bending test	Sub-clause 6.1.4 (1)	No evidence of mechanical damage.
'	Substitute bending test	The resistor shall be mounted on the test	TWO evidence of medianical damage.
		substrate as shown in Figure—3.	
		Bending value: 5 mm	
		(Among the fulcrums: 90 mm)	
		Duration: 10 s ± 1 s	
8	Resistance to soldering	Sub-clause 6.10	RHC16
	heat	Test by a piece.	100MΩ≤R≤10GΩ: Within ±1 %
		Temp. of solder bath: $260 ^{\circ}\text{C} \pm 5 ^{\circ}\text{C}$	10GΩ <r≤150gω: %<="" td="" within="" ±2=""></r≤150gω:>
		Immersion time: 10 s ± 1 s	RHC20
		After immersion into solder, leaving at the room	100MΩ≤R≤10GΩ: Within ±1 %
		temp. for 1h or more and then measure the	100GΩ≤R≤150GΩ: Within ±5 %
		resistance.	No evidence of appearance damage
9	Solderability	Sub-clause 6.11	The surface of terminal immersed shall be
		Test by a piece.	min. of 95% covered with a new coating of
		Flux: Rosin-Methanol	solder.
		Temp. of solder bath: 235 $^{\circ}$ C \pm 5 $^{\circ}$ C	
		Immersion time: $2 s \pm 0.5 s$	
	1		

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Table-4(2)

No.	Test items	Condition of test (JIS C 5202)		Performance requirements	
10	Temperature cycling	Sub-clause 7.4		RHC16	
		Test cyc	le: 5 cycles for duty cyc	cle as specified	100MΩ≤R≤10GΩ: Within ±1 %
		below.			10GΩ <r≤150gω: %<="" td="" within="" ±2=""></r≤150gω:>
		Step	Temperature (°C)	Time (min)	RHC20
		1	Room temp.	2~3	100MΩ≤R≤10GΩ: Within ±1 %
		2	-55±3	30	100GΩ≤R≤150GΩ: Within ±5 %
		3	Room temp.	2~3	No evidence of appearance damage
		4	RHC16: 155±2	20	
		4	RHC20: 125±2	30	
11	Humidity	Sub-clause 7.5		RHC16	
		Test temp. & relative humidity:		100MΩ≤R≤10GΩ: Within ±2 %	
		40 °C ± 2 °C & 90~95 %			10GΩ <r≤150gω: %<="" td="" within="" ±5=""></r≤150gω:>
		Test period: 1,000 +48 h			RHC20
					100MΩ≤R≤10GΩ: Within ±2 %
					100GΩ≤R≤150GΩ: Within ±5 %
					No evidence of appearance damage
12	Load life	Sub-clause 7.10			RHC16
		Test temp. & relative humidity:			100MΩ \leq R \leq 10GΩ: Within \pm 3 %
		70 °C ± 2 °C			10GΩ <r≤150gω: %<="" td="" within="" ±5=""></r≤150gω:>
		Test voltage: Cycle of 1 h 30 min. "ON" and 30			RHC20
		min. "OFF" at dc rated voltage.			100MΩ≤R≤10GΩ: Within ±3 %
		Test peri	Test period: 1,000 +48 h		100GΩ≤R≤150GΩ: Within ±20 %
		, , , , , , , , , , , , , , , , , , , ,			No evidence of appearance damage

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7. Test substrate

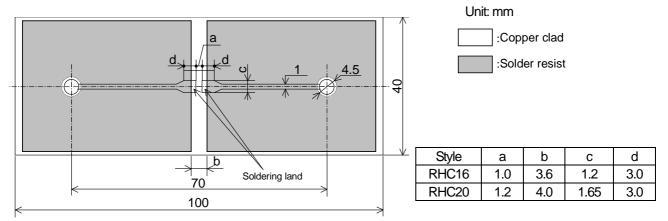
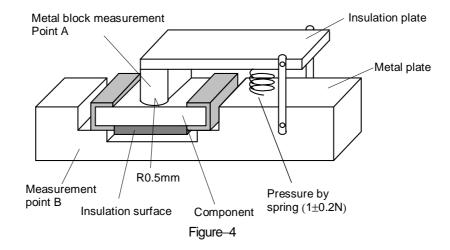


Figure-3 RHC BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm



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8. Taping

- 8.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions

Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-5 and Table-5.

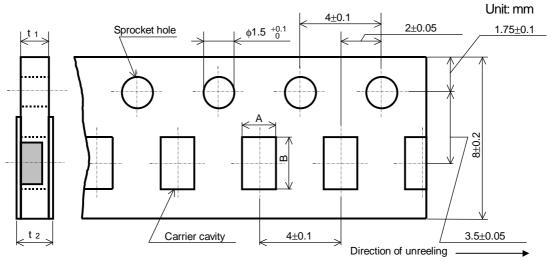
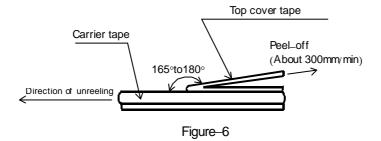


Figure-5 Table-5 Unit: mm Style Α В t₁ t 2 RHC16 1.15±0.15 1.9±0.2 0.6 ± 0.1 0.8max. RHC20 1.65±0.15 2.5 ± 0.2 0.8 ± 0.1 1.0max.

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

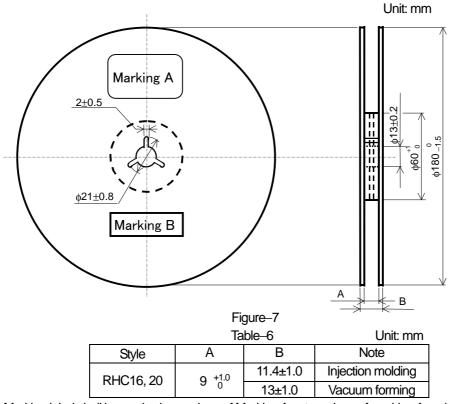


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8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-6. Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

8.4 Leader and trailer tape.

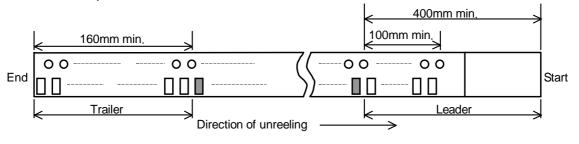


Figure-8

9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

- (1) Classification (Style, Rated resistance, Tolerance on rated resistance, Packaging form)
- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark
- 9.2 Marking B (KAMAYA Control label)

单击下面可查看定价,库存,交付和生命周期等信息

>>Kamaya(釜屋电机)